



DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D T _A = +25°C
20V	$13m\Omega @ V_{GS} = 4.5V$	9.0A
	$14m\Omega @ V_{GS} = 4.0V$	8.7A
	$17m\Omega @ V_{GS} = 3.1V$	8.0A
	$18m\Omega @ V_{GS} = 2.5V$	6.7A
	$28m\Omega$ @ $V_{GS} = 1.8V$	6.3A

Description

This new generation MOSFET has been designed to minimize the onstate resistance $(R_{DS(ON)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Power Management Functions
- Battery Pack
- Load Switch

Features

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

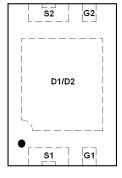
- Case: U-DFN2030-6 (Type B)
- Case Material: Molded Plastic, "Green" Molding Compound UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Weight: 0.012 grams (Approximate)



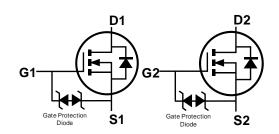
U-DFN2030-6 (Type B)



Bottom View



Top View



Equivalent Circuit

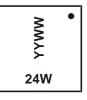
Ordering Information (Note 4)

Part Number	Case	Packaging
DMN2014LHAB-7	U-DFN2030-6 (Type B)	3,000 / Tape & Reel
DMN2014LHAB-13	U-DFN2030-6 (Type B)	10.000 / Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



24W = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 16 for 2016) WW = Week code (01 to 53)



Maximum Ratings $(@T_A = +25^{\circ}C, \text{ unless otherwise specified.})$

Character	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	20	V		
Gate-Source Voltage	V _{GSS}	±12	V		
Continuous Dunis Courset (Nata CVV	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I _D	9.0 7.1	А
Continuous Drain Current (Note 6) V _{GS} = 4.5V	t < 10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	9.3 7.4	А
Pulsed Drain Current (10µs Pulse, Duty Cycle =	I _{DM}	45	Α		

Thermal Characteristics

Characteristic		Symbol	Value	Units	
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	P _D	0.8	W	
Total Power Dissipation (Note 5)	$T_A = +70^{\circ}C$	PD	0.5		
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	157	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t < 10s	$R_{\theta JA}$	148		
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	D-	1.7	W	
Total Fower Dissipation (Note 0)	$T_A = +70^{\circ}C$	P_{D}	1.1		
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	<u> </u>	73.7		
Thermal Resistance, Junction to Ambient (Note 0)	t < 10s	$R_{\theta JA}$	68	°C/W	
Thermal Resistance, Junction to Case		$R_{ heta JC}$	9.4		
Operating and Storage Temperature Range		$T_{J_i} T_{STG}$	-55 to +150	°C	

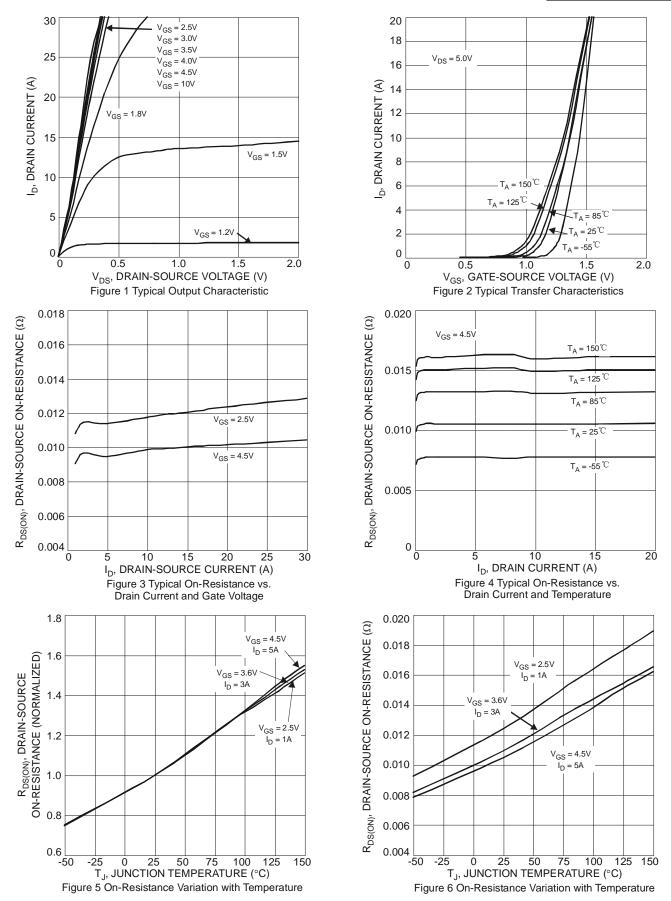
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	20	_		V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	I	_	1.0	μA	$V_{DS} = 20V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	1	_	±10	μΑ	$V_{GS} = \pm 8V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	0.3	0.71	1.1	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
			10	13		$V_{GS} = 4.5V, I_D = 4.0A$	
			11	14		$V_{GS} = 4.0V, I_D = 4.0A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	12	17	mΩ	$V_{GS} = 3.1V, I_D = 4.0A$	
			13	18		$V_{GS} = 2.5V, I_D = 4.0A$	
			19	28		$V_{GS} = 1.8V, I_D = 3.5A$	
Forward Transfer Admittance	Y _{fs}	_	25	_	S	$V_{DS} = 5V, I_{D} = 6A$	
Diode Forward Voltage	V _{SD}	-	0.75	1.0	V	$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{iss}	1	1550	_	pF	1/ 401/1/ 01/	
Output Capacitance	Coss		166	_	pF	$V_{DS} = 10V, V_{GS} = 0V,$ -f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}		145	_	pF	1 = 1:0WH 12	
Gate Resistance	R_g		1.37	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 2.5V)	Q_{g}	-	8.4	_	nC		
Total Gate Charge (V _{GS} = 4.5V)	Q_{g}	-	16	_	nC	$V_{DS} = 10V, I_{D} = 6A$	
Gate-Source Charge	Q_{gs}	_	2.3	_	nC		
Gate-Drain Charge	Q _{qd}	_	2.5	_	nC		
Turn-On Delay Time	t _{D(ON)}		6.9	_	ns	$V_{DD} = 10V, R_L = 1.7\Omega,$ $V_{GS} = 5.0V, R_g = 3\Omega$	
Turn-On Rise Time	t _R	_	15.5	_	ns		
Turn-Off Delay Time	t _{D(OFF)}	_	40.9	_	ns		
Turn-Off Fall Time	t _F		12	_	ns		

Notes:

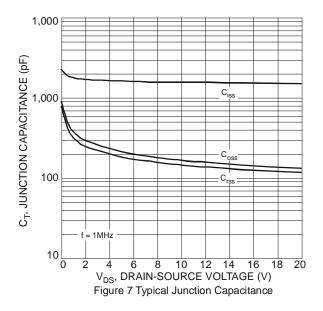
- Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad
 Repetitive rating, pulse width limited by junction temperature
 Guaranteed by design. Not subject to product testing

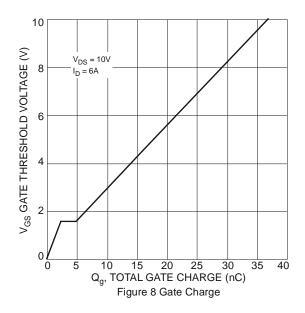


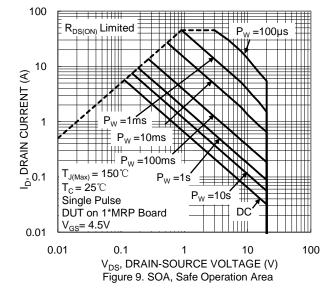


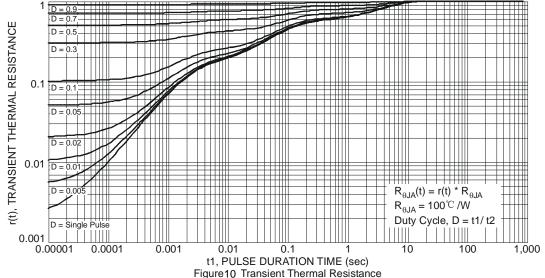










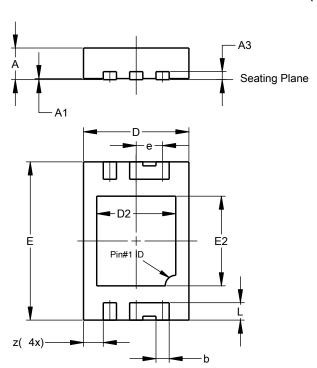




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2030-6 (Type B)

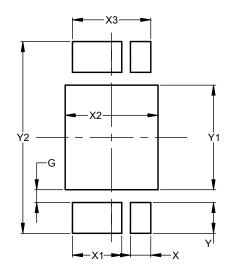


U-DFN2030-6					
(Type B)					
Dim	Min	Max	Тур		
Α	0.55	0.65	0.60		
A1	0.00	0.05	0.02		
A3			0.15		
b	0.20	0.30	0.25		
D	1.95	2.05	2.00		
D2	1.40	1.60	1.50		
E	2.95	3.05	3.00		
E2	1.65	1.75	1.70		
е			0.50		
L	0.28	0.38	0.33		
Z			0.375		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2030-6 (Type B)



Dimensions	Value		
Dilliensions	(in mm)		
G	0.220		
Х	0.350		
X1	0.850		
X2	1.600		
Х3	1.350		
Y	0.530		
Y1	1.800		
Y2	3.300		



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